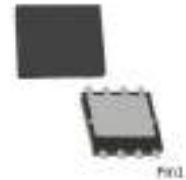


Features

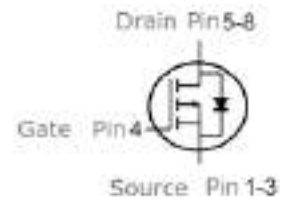
- P-Channel, -5V Logic Level Control
- Very low on-resistance RDS(on) @ VGS=-4.5 V
- Fast Switching
- Enhancement mode
- Pb-free lead plating; RoHS compliant

| | | |
|---------------------------------|-----|----|
| V_{DS} | -30 | V |
| $R_{DS(on),TYP} @ V_{GS}=-10V$ | 8.5 | mΩ |
| $R_{DS(on),TYP} @ V_{GS}=-4.5V$ | 15 | mΩ |
| I_D | -47 | A |

PDFN3333



| Part ID | Package Type | Marking | Tape and reel information |
|---------|--------------|---------|---------------------------|
| TCS1347 | PDFN3333 | | 5000pcs/Reel |



Maximum ratings, at T_A =25°C, unless otherwise specified

| Symbol | Parameter | Rating | Unit | |
|----------------|--|-------------|------|---|
| $V_{(BR)DSS}$ | Drain-Source breakdown voltage | -30 | V | |
| V_{GS} | Gate-Source voltage | ±20 | V | |
| I_S | Diode continuous forward current | $T_C=25°C$ | -47 | A |
| I_D | Continuous drain current @VGS=-10V | $T_C=25°C$ | -47 | A |
| | | $T_C=100°C$ | -30 | A |
| I_{DM} | Pulse drain current tested ① | $T_C=25°C$ | -188 | A |
| I_{DSM} | Continuous drain current @VGS=-10V | $T_A=25°C$ | 14 | A |
| | | $T_A=70°C$ | 11 | A |
| EAS | Avalanche energy, single pulsed ② | 81 | mJ | |
| P_D | Maximum power dissipation | $T_C=25°C$ | 38 | W |
| P_{DSM} | Maximum power dissipation ③ | $T_A=25°C$ | 3.5 | W |
| MSL | | Level 3 | | |
| T_{STG}, T_J | Storage and Junction Temperature Range | -55 to 150 | °C | |

Thermal Characteristics

| Symbol | Parameter | Typical | Unit |
|-----------|---|---------|------|
| $R_{θJC}$ | Thermal Resistance, Junction-to-Case | 3.3 | °C/W |
| $R_{θJA}$ | Thermal Resistance, Junction-to-Ambient | 35 | °C/W |

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Unit |
|---|--|---|------|-------|------|------|
| Static Electrical Characteristics @ T_j = 25°C (unless otherwise stated) | | | | | | |
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V, I _D =-250μA | -30 | -- | -- | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =-30V, V _{GS} =0V | -- | -- | -1 | μA |
| | Zero Gate Voltage Drain Current(T _j =125°C) | V _{DS} =-30V, V _{GS} =0V | -- | -- | -100 | μA |
| I _{GSS} | Gate-Body Leakage Current | V _{GS} =±20V, V _{DS} =0V | -- | -- | ±100 | nA |
| V _{GS(TH)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =-250μA | -1.0 | -1.8 | -2.5 | V |
| R _{DS(ON)} | Drain-Source On-State Resistance ④ | V _{GS} =-10V, I _D =-20A | -- | 8.5 | 11 | mΩ |
| R _{DS(ON)} | Drain-Source On-State Resistance ④ | V _{GS} =-4.5V, I _D =-10A | -- | 15 | 20 | mΩ |
| Dynamic Electrical Characteristics @ T_j = 25°C (unless otherwise stated) | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} =-15V, V _{GS} =0V, f=1MHz | -- | 3320 | -- | pF |
| C _{oss} | Output Capacitance | | -- | 395 | -- | pF |
| C _{rss} | Reverse Transfer Capacitance | | -- | 245 | -- | pF |
| R _g | Gate Resistance | f=1MHz | -- | 2.3 | -- | Ω |
| Q _g | Total Gate Charge | V _{DS} =-15V, I _D =-10A, V _{GS} =-10V | -- | 39 | -- | nC |
| Q _{gs} | Gate-Source Charge | | -- | 7 | -- | nC |
| Q _{gd} | Gate-Drain Charge | | -- | 11 | -- | nC |
| Switching Characteristics | | | | | | |
| t _{d(on)} | Turn-on Delay Time | V _{DD} =-15V, I _D =-10A, R _G =6.8Ω, V _{GS} =-10V | -- | 15 | -- | nS |
| t _r | Turn-on Rise Time | | -- | 33 | -- | nS |
| t _{d(off)} | Turn-Off Delay Time | | -- | 67 | -- | nS |
| t _f | Turn-Off Fall Time | | -- | 21 | -- | nS |
| Source- Drain Diode Characteristics @ T_j = 25°C (unless otherwise stated) | | | | | | |
| V _{SD} | Forward on voltage | I _{SD} =-20A, V _{GS} =0V | -- | -0.89 | -1.2 | V |
| t _{rr} | Reverse Recovery Time | T _j =25°C, I _{sd} =-10A, V _{GS} =0V | -- | 29 | -- | nS |
| Q _{rr} | Reverse Recovery Charge | di/dt=-100A/μs | | 144 | | nC |

NOTE:

- ① Repetitive rating; pulse width limited by max junction temperature.
- ② Limited by T_{Jmax}, starting T_J = 25°C, L = 0.5mH, R_G = 25Ω, I_{AS} = -18A, V_{GS} = -10V. Part not recommended for use above this value
- ③ The power dissipation P_{DSM} is based on R_{θJA} and the maximum allowed junction temperature of 150°C.
- ④ Pulse width ≤ 300μs; duty cycle ≤ 2%.

Typical Characteristics

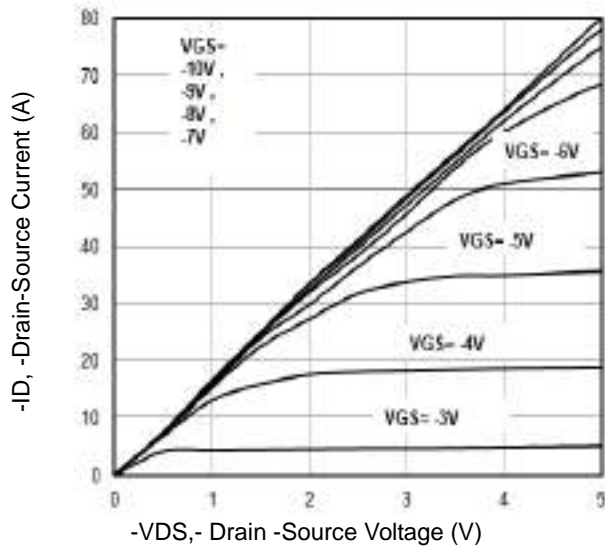


Fig1. Typical Output Characteristics

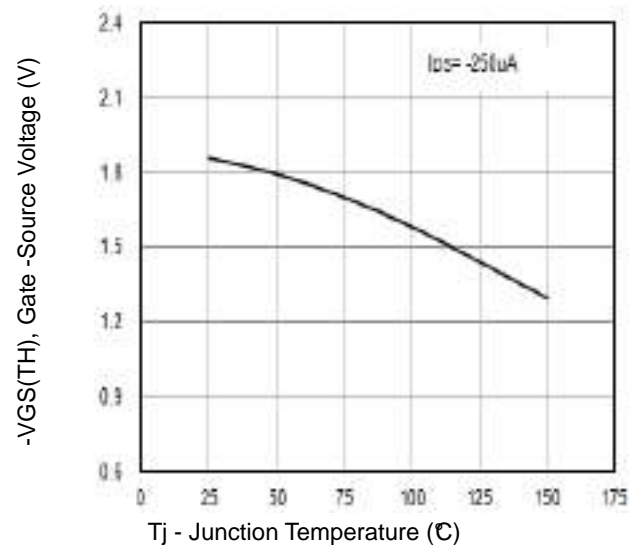


Fig2. $-V_{GS(TH)}$ Gate -Source Voltage Vs. T_j

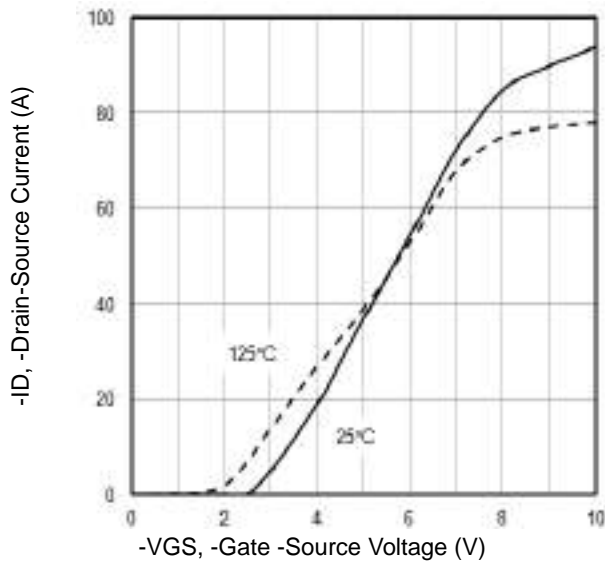


Fig3. Typical Transfer Characteristics

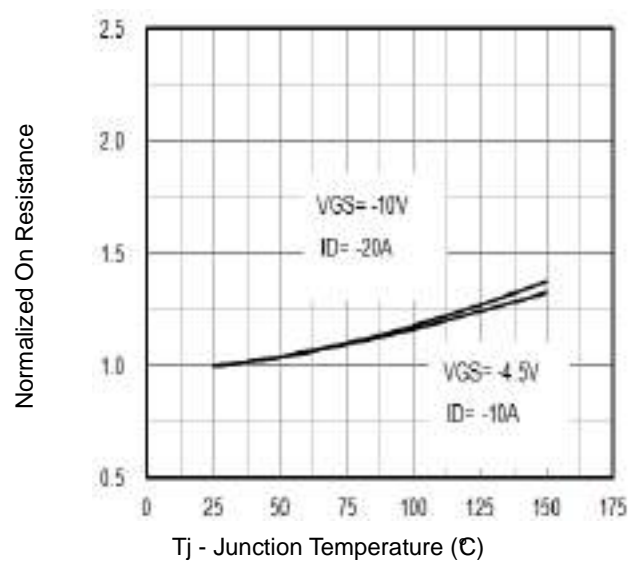


Fig4. Normalized On-Resistance Vs. T_j

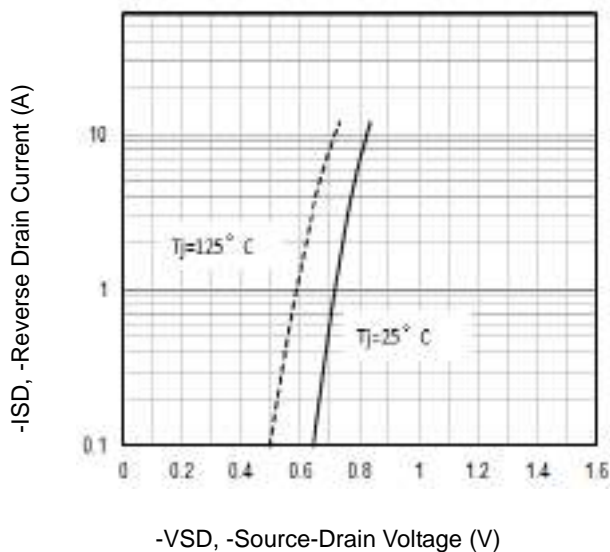


Fig5. Typical Source-Drain Diode Forward Voltage

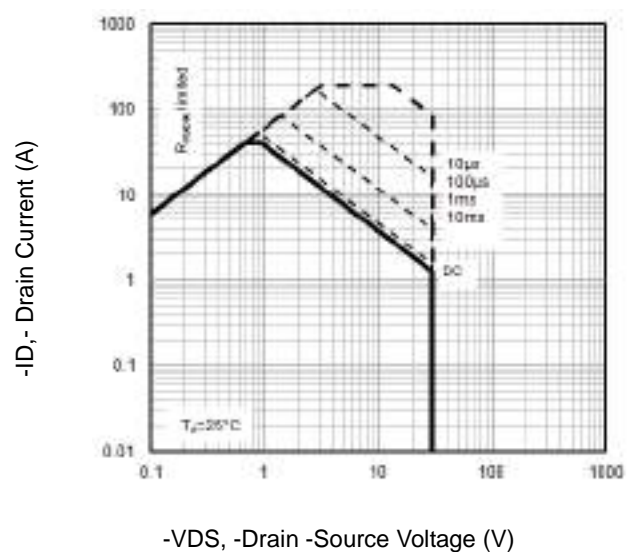
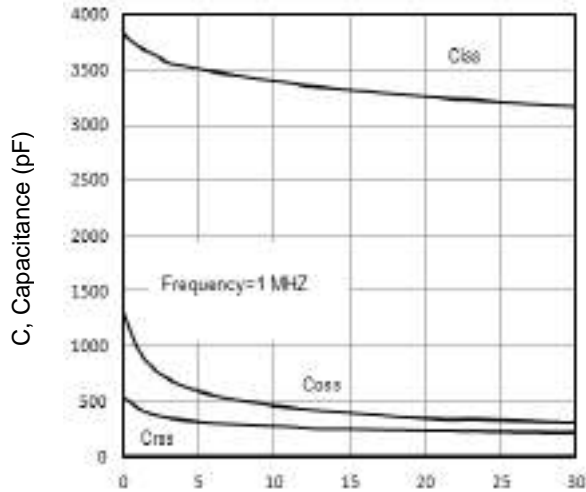


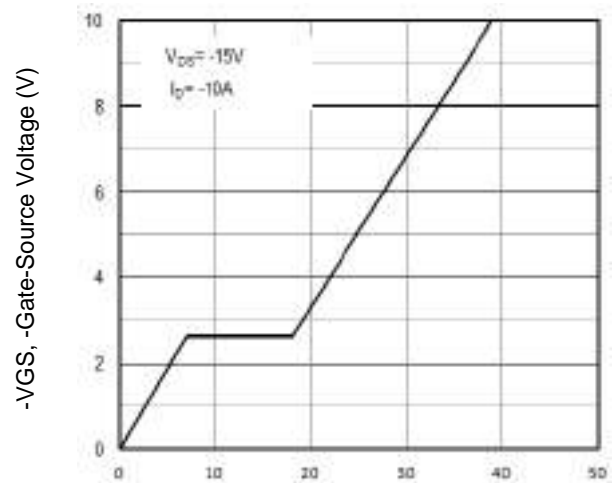
Fig6. Maximum Safe Operating Area

Typical Characteristics



-VDS, -Drain-Source Voltage (V)

Fig7. Typical Capacitance Vs. Drain-Source Voltage



Qg -Total Gate Charge (nC)

Fig8. Typical Gate Charge Vs. Gate-Source Voltage

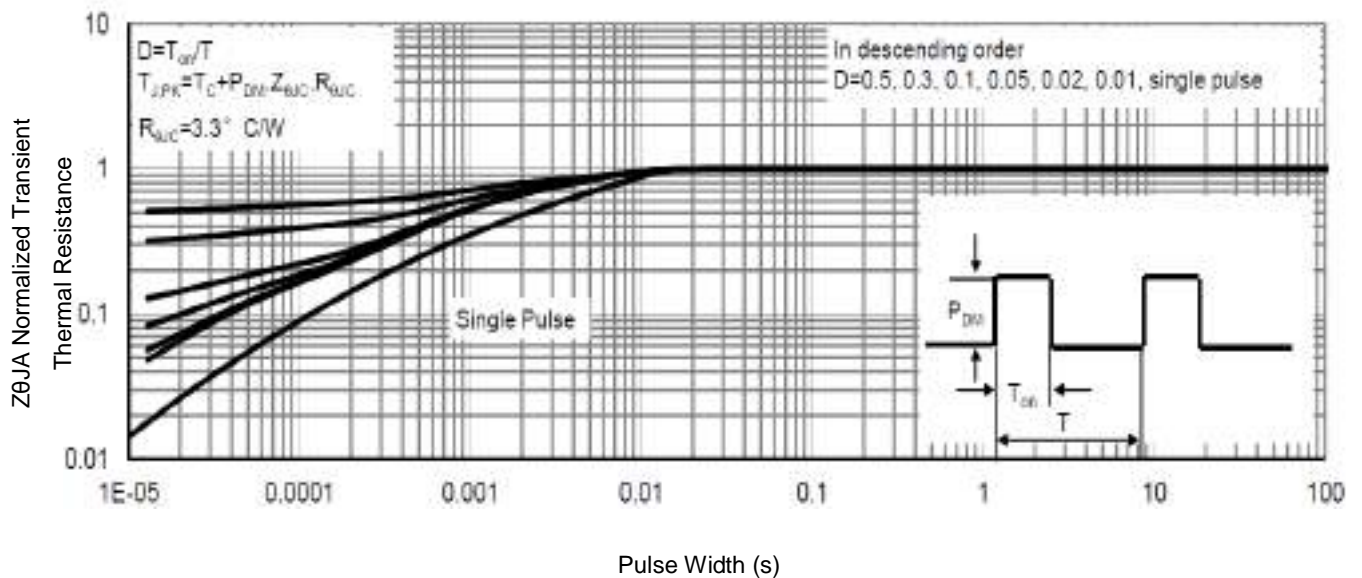


Fig9. Normalized Maximum Transient Thermal Impedance

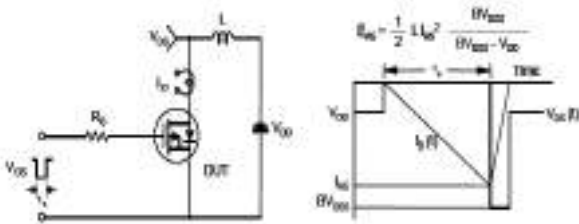


Fig10. Unclamped Inductive Test Circuit and Waveforms

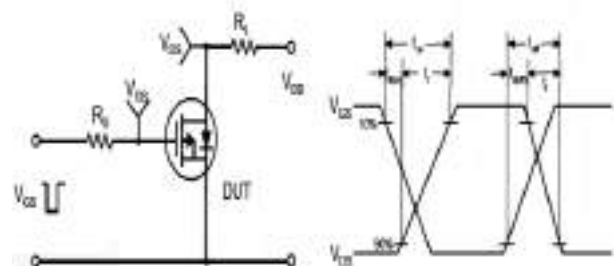
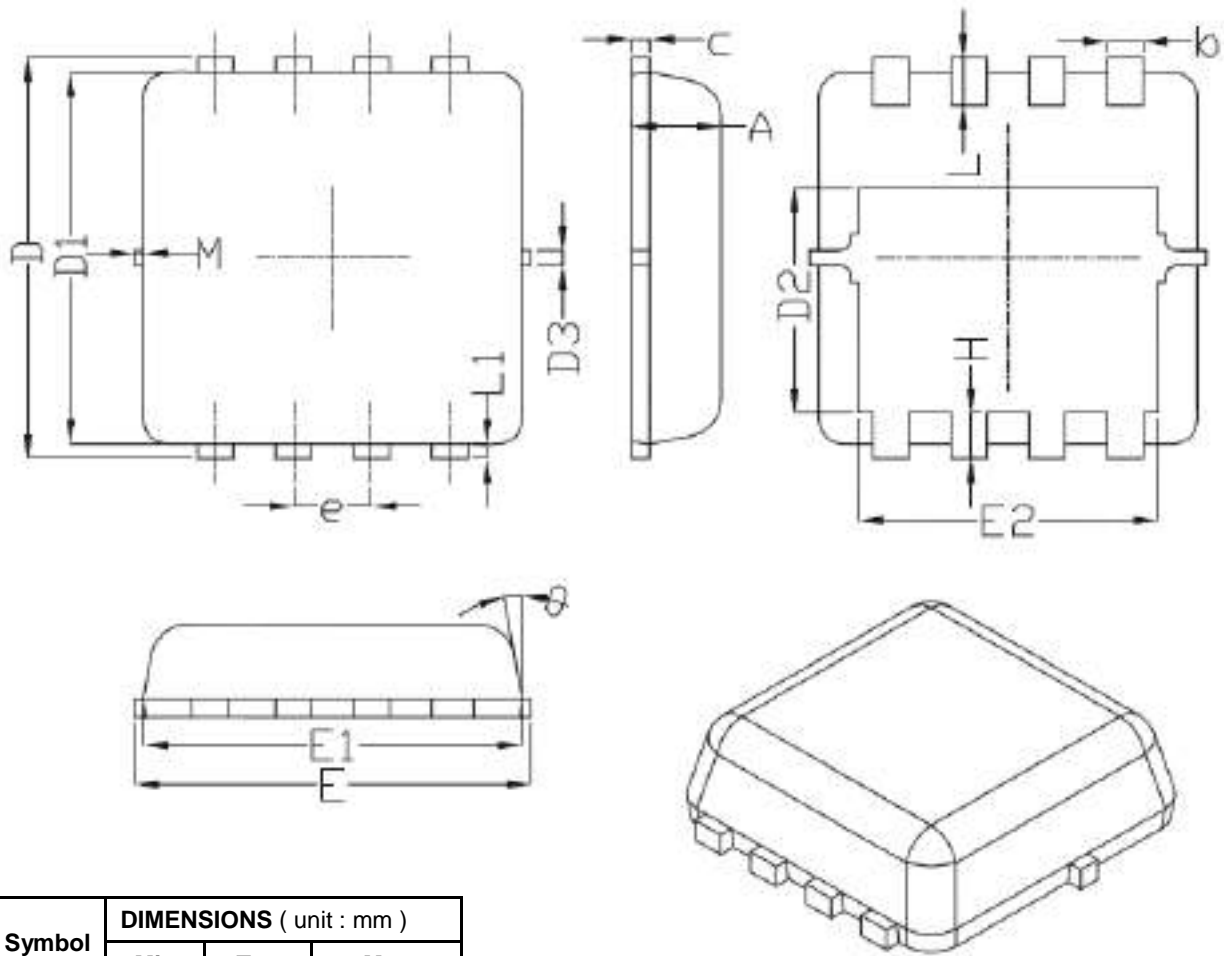


Fig11. Switching Time Test Circuit and waveforms

PDFN3333 Package Outline Data



| Symbol | DIMENSIONS (unit : mm) | | |
|-----------------|--------------------------|------|------|
| | Min | Typ | Max |
| A | 0.7 | 0.75 | 0.8 |
| b | 0.25 | 0.3 | 0.35 |
| C | 0.1 | 0.15 | 0.25 |
| D | 3.25 | 3.35 | 3.45 |
| D1 | 3 | 3.1 | 3.2 |
| D2 | 1.78 | 1.88 | 1.98 |
| D3 | -- | 0.13 | -- |
| E | 3.2 | 3.3 | 3.4 |
| E1 | 3 | 3.15 | 3.2 |
| E2 | 2.39 | 2.49 | 2.59 |
| e | 0.65 BSC | | |
| H | 0.3 | 0.39 | 0.5 |
| L | 0.3 | 0.4 | 0.5 |
| L1 | -- | 0.13 | -- |
| θ | -- | 10° | 12° |
| M | * | * | 0.15 |
| * Not specified | | | |

Notes:

1. Follow JEDEC MO-240 variation CA.
2. Dimensions "D1" and "E1" do NOT include mold flash protrusions or gate burrs.
3. Dimensions "D1" and "E1" include interterminal flash or protrusion. Interterminal flash or protrusion shall not exceed 0.25mm per side.